P30024.A06



Applicants : Kouji NISHIOKA et al.

Group Art Unit: 2875

Appln. No. : 10/596,019

Examiner: SEAN P. GRAMLING

Filed : May 25, 2006

Confirmation No.: 1772

For

: LIGHT EMITTING DEVICE USING LIGHT EMITTING DIODE CHIP

## SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
U.S. Patent and Trademark Office
Customer Service Window, Mail Stop Amendment
Randolph Building
401 Dulany Street
Alexandria, VA 22314

Sir:

In accordance with the duty of disclosure under 37 C.F.R. § 1.56 and §§1.97-1.98, and supplemental to the Information Disclosure Statement that was previously filed on August 10, 2006, Applicants hereby bring to the attention of the Examiner a Japanese Office Action dated December 2, 2008 with respect to patent family member Japanese Patent Application No. 2003-394532, in which the following documents were cited:

- (1) Japanese Patent Publication No. 2002-525814 A, which is accompanied by an English language Abstract thereof, and patent family members International Patent Publication No. WO 00/17569 A1 and U.S. Patent No. US 6,220,722 B1;
- (2) Japanese Patent Publication No. 8-107235 A, which is accompanied by an English language Abstract thereof;
- (3) Japanese Patent Publication No. 2000-058925 A; and

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## (4) Japanese Patent Publication No. 2003-318448 A.

The relevance of these documents, as ascertained with respect to the Japanese claims by the Japanese Examiner, is set forth in the Japanese Office Action.

Applicants note that documents (3) and (4) were previously cited in the Information Disclosure Statement that was filed on August 10, 2006. Thus, copies of these documents are not provided herewith.

Further to 37 C.F.R. §1.98 (a)(2)(ii), a copy of the U.S. patent publication is not enclosed herewith. However, if a copy is needed, the Examiner is respectfully requested to contact the undersigned.

Applicants respectfully request that the Examiner consider the above material and cite the same. Copies of the above-noted foreign and international documents (1) – (2), including the noted English language Abstracts, are attached hereto, and all of the documents are listed on the attached PTO-1449 Form. Copies of the Japanese Office Action and an English language translation thereof are also attached hereto. The Examiner is requested to initial the appropriate spaces on the attached Form and to return a copy of the completed Form to Applicants with the next official communication in the present application.

Applicants note that this Supplemental Information Disclosure Statement is being submitted subsequent to the issuance of a Non-Final Office Action mailed on February 2, 2009. In accordance with 37 C.F.R. §1.97(d), Applicants hereby certify that each item of information contained in the Information Disclosure Statement was first cited in any communication from an foreign patent office in a counterpart foreign application not more than three months prior to the filing of the Information Disclosure Statement. Thus no fee is believed necessary to ensure consideration of the submitted material.

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Should the Examiner have any questions, the Examiner is invited to contact the undersigned at the below-listed telephone number.

Respectfully submitted, Kouji NISHIOKA et al.

Bruce H. Bernstein

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